



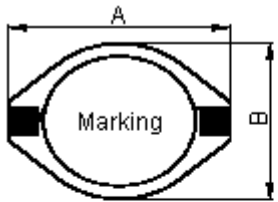
PART NO.

MCBF7330-1R0MU

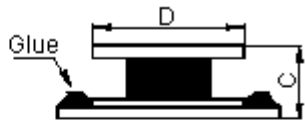
REVISIONS

ECN #	REV	DESCRIPTION	DRAWN	DATE	CHECKD	DATE	APPRVD	DATE
-	A	RELEASED	Arun	12/2/11	Jagan	12/2/11	Farnell	29/2/11

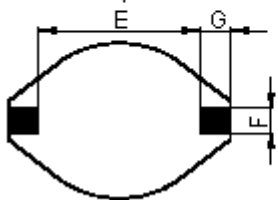
Configurations and Dimensions



Top View



Side View



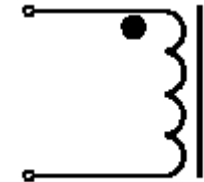
Bottom View



Suggest PCB Layout  
Dimensions : Millimetres

A	18.54 mm	Maximum
B	15.24 mm	Maximum
C	7.11 mm	Maximum
D	12.7 ±0.3 mm	-
E	12.92 mm	Reference
F	2.54 mm	Reference
G	2.54 mm	Reference

Schematic Diagram



Note:

- (1) Wire Ø0.4mm x 1P 2UEWF 155°C
- (2) 39.5TS (Reference)

Marking : 101  
YYWW

YY : Year  
WW : Week

Electrical Characteristics

(at 25°C)

Test Condition		
100KHz 0.25V	L	100µH ±20%
at 25°C	DCR	190mΩ (Maximum)
100KHz 0.25V I <sub>rms</sub> = 1.8A	ΔT	Temperature rise 40°C (Maximum)

Operating temperature: -40°C to +125°C

Test Data for Mechanical

Test Item	A mm	B mm	C mm	D mm	E mm	F mm	G mm
Specification	18.54 (Maximum)	15.24 (Maximum)	7.11 (Maximum)	12.7 ±0.3	12.92 (Reference)	2.54 (Reference)	2.54 (Reference)
1	18.05	14.07	6.34	12.73	13.21	2.54	2.57
2	18.12	14.06	6.35			2.53	2.54
3	18.08	14.05	6.33	12.74	13.26	2.5	2.56
4	18.07	14.06	6.38	12.76	13.21	2.54	2.58
5	18.06	14.01	6.29	12.75	13.19	2.5	2.54
Average	18.08	14.05	6.34	12.74	13.22	2.52	2.56

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Arun	12/02/11
CHECKED BY:	DATE:
Jagan	12/02/11
APPROVED BY:	DATE:
Farnell	29/02/11

DRAWING TITLE:

Inductor

SIZE	DWG NO.	ELECTRONIC FILE	REV
A	M10003206	BF7330-101MU	A
SCALE: NTS	U.O.M.: mm	SHEET: 1	OF 3



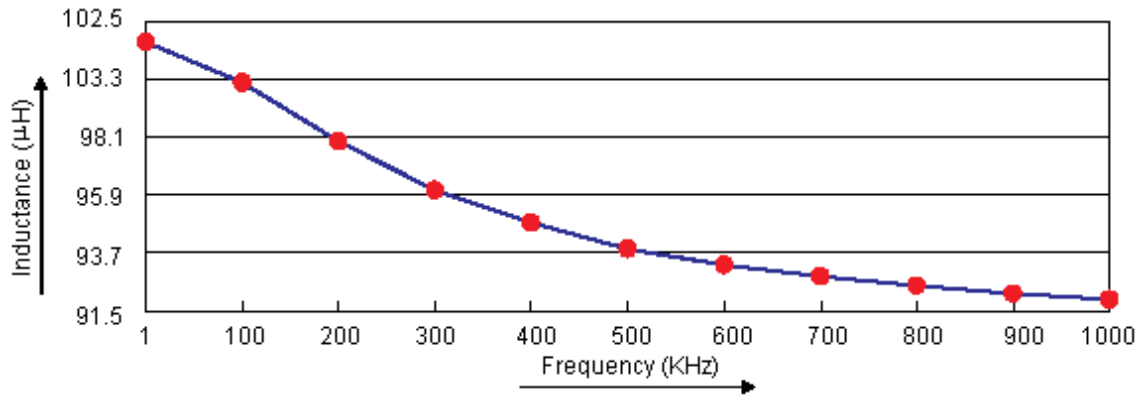
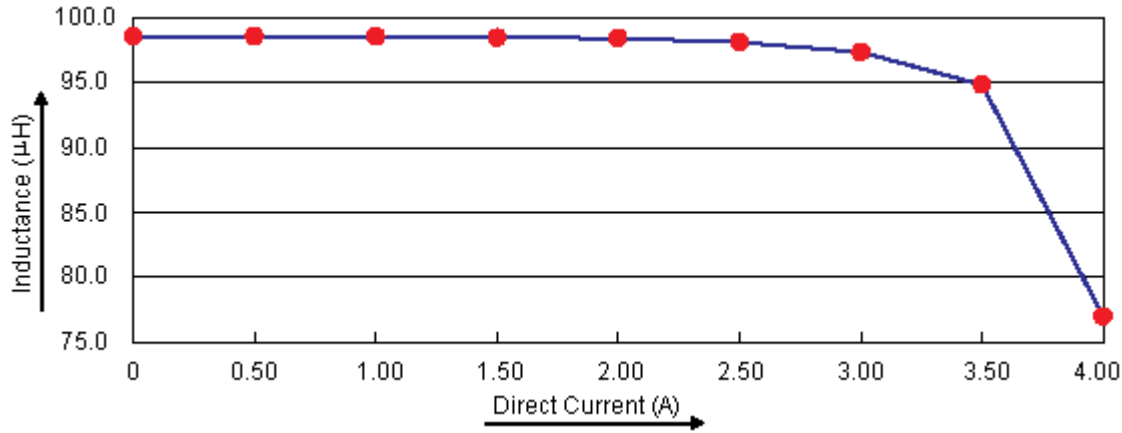
PART NO.

BF7330-101MU

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-	A	RELEASED	Arun	12/2/11	Jagan	12/2/11	Farnell	29/2/11

Electric Characteristics



Test Data for Electrical

Test Item	L µH	DCR mΩ	ΔT
Condition	100KHz 0.25V	at 25°C	100KHz 0.25V I <sub>rms</sub> = 1.8A
Specification	100 ±20%	190 (Maximum)	Temperature Rise 40°C (Maximum)
1	99.2	141.1	OK
2	98.5	140.7	OK
3		141.9	OK
4	98.3	141.6	OK
5	98.2	141.3	OK
Average	98.54	141.32	OK

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Jagan	12/02/11
APPROVED BY:	DATE:
Farnell	29/02/11

DRAWING TITLE:

Inductor

SIZE A	DWG NO. M10003206	ELECTRONIC FILE BF7330-101MU	REV A
SCALE: NTS	U.O.M.: mm	SHEET: 2 OF 3	



PART NO.

BF7330-101MU

REVISIONS

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Reliability Test

Test Item	Specifications	Test Method and Remarks
Operating temperature range	-40°C to +125°C	Including temperature rise due to self-generated heat.
Storage Condition	Ambient temperature : 0°C to 40°C Humidity : Below 70%RH	To maintain the solderability of terminal electrodes, care must be taken to control temperature and humidity in the storage area.
Moisture sensitivity	Appearance : No abnormality No damage DCR change : Within ±20% Inductance change : Within ±20%	According to J-STD-020B level 3 Test condition : 60°C 60% RH Test duration : 40 hours Recovery : 1 to 2 hours of recovery under the standard condition after the removal from the test chamber.
Solderability	All termination shall exhibit a continuous solder coating free from defects for a minimum 90% of the surface area of any individual lead.	According to J-STD-002B Steam aging category : 97°C 98% RH Steam aging duration : 8 hours Solder : Lead-free solder Solder temperature : 260 ±5°C Dip time : 5 +0/-0.5 seconds.

Material List

No.	Item	Material Description
1	Core	T2 DR12.7 x 5.6C B5.8 F3.3
2	Wire	Ø0.4mm x 1P 2UEWF 155°C
3	Solder (Lead Free)	Sn99.3% / Cu0.7%
4	Glue	TH320
3	Base	DAP HD127-3

Part Number Table

Description	Part Number
Inductor, 100µH, 20%, SMD	MCBF7330-101MU

<http://www.farnell.com>

<http://www.newark.com>

<http://www.cpc.co.uk>

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DRAWING TITLE:			
Inductor			
SIZE	DWG NO.	ELECTRONIC FILE	REV
A	M10003206	BF7330-101MU	A
SCALE: NTS	U.O.M.: mm	SHEET: 3 OF 3	